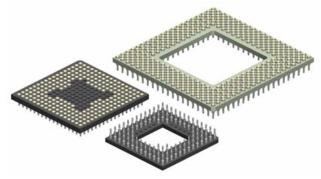
Pin Grid Array Sockets



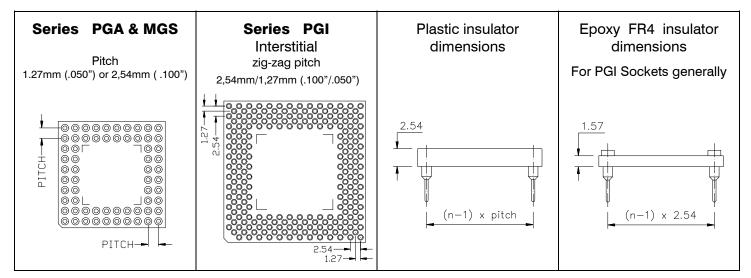


E-tec offers any configuration. You may choose between open frame and closed frame socket bodies.

The E-tec PGA sockets with Insulator code "S" will be supplied either in plastic or FR4 Epoxy depending on material availability. If you wish to receive the sockets in FR4 Epoxy material only, then you need to specify the code "E" in the order code. If you only accept plastic, then you have to request E-tec for availability first.

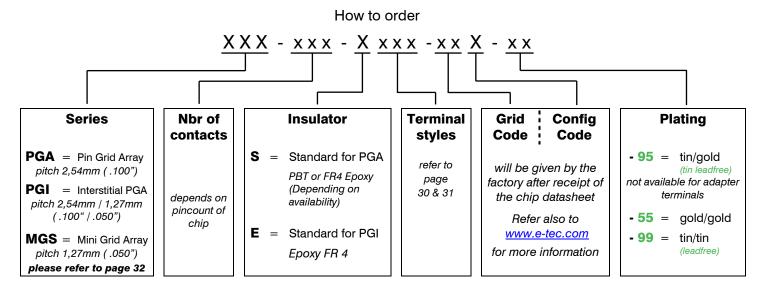


All interstitial PGA (PGI) and Mini-Grid sockets (MGS) in any grid size and standard PGA sockets with grid size 19x19 or higher are delivered in FR4 Epoxy only.



Specifications

Mechanical data Insertion force (avg) Extraction force (standard) Contact life Solderability Contact security: -Vibration -Shock	0,70 N for PGA / 0,40 N for PGI 0,25 N for PGA / 0,15 N for PGI > 100 cycles as per IEC 60068-2-58 as per EN60352-4 as per EN60352-4	Electrical data Contact resistance at 1A Current rating Contact capacitance at 1MHz Insulation resistance at 500V DC Breakdown voltage at 60 Hz Contact resistance	4,3 mΩ typ. 1A max., 100V 2 pF max. 5 × 10 ⁹ Ω min. 500 V AC ≤7 mΩ
Material Insulator: "S" version (RoHS compliant) "E" version (RoHS compliant) Terminal (RoHS compliant) Contact (RoHS compliant)	PBT UL 94 V-0 Epoxy FR4 CuZn BeCu	Operating temperature -55° C to +125° C More information, for example about testresult please ref. to page 49 or contact E-tec.	



PGA/PGI - Series Socket Terminal Styles





